## FEATURES

1.8 V to 5.5 V single supply
$5 \Omega$ (maximum) on resistance
$0.75 \Omega$ (typical) on resistance flatness
Automotive temperature range: $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
-3 dB bandwidth > $\mathbf{2 0 0} \mathbf{~ M H z}$
Rail-to-rail operation
6-lead SC70 package
Fast switching times
$t_{0}=12 \mathrm{~ns}$
$t_{\text {off }}=6 \mathrm{~ns}$
Typical power consumption ( $<0.01 \mu \mathrm{~W}$ )
TTL/CMOS compatible

## APPLICATIONS

Battery-powered systems
Communication systems
Sample-and-hold systems
Audio signal routing
Video switching
Mechanical reed relay replacement

## GENERAL DESCRIPTION

The ADG749 is a monolithic CMOS SPDT switch. This switch is designed on a submicron process that provides low power dissipation yet gives high switching speed, low on resistance, and low leakage currents.

The ADG749 can operate from a single-supply range of 1.8 V to 5.5 V , making it ideal for use in battery-powered instruments and with the new generation of DACs and ADCs from Analog Devices, Inc.

Each switch of the ADG749 conducts equally well in both directions when on. The ADG749 exhibits break-before-make switching action.
Because of the advanced submicron process, -3 dB bandwidths of greater than 200 MHz can be achieved.

The ADG749 is available in a 6-lead SC70 package.

## FUNCTIONAL BLOCK DIAGRAM



SWITCH SHOWN FOR
A LOGIC 1 INPUT
Figure 1.

## PRODUCT HIGHLIGHTS

1. 1.8 V to 5.5 V Single-Supply Operation. The ADG749 offers high performance, including low on resistance and fast switching times, and is fully specified and guaranteed with 3 V and 5 V supply rails.
2. Very Low Ron ( $5 \Omega$ Maximum at 5 V and $10 \Omega$ Maximum at 3 V ). At 1.8 V operation, Ros is typically $40 \Omega$ over the temperature range.
3. Automotive Temperature Range: $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
4. On Resistance Flatness ( $\left.\mathrm{R}_{\mathrm{flat}(\mathrm{ON})}\right)(0.75 \Omega$ typical).
5. -3 dB Bandwidth $>200 \mathrm{MHz}$.
6. Low Power Dissipation. CMOS construction ensures low power dissipation.
7. Fast $\mathrm{t}_{\mathrm{on}} / \mathrm{t}_{\text {off }}$.
8. Tiny, 6-lead SC70 Package.
[^0]
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## SPECIFICATIONS

$\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 10 \%$ and $\mathrm{GND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ unless otherwise stated.
Table 1.

| Parameter | $25^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH <br> Analog Signal Range <br> On Resistance (Ron) <br> On Resistance Match Between Channels ( $\Delta$ Ron) <br> On Resistance Flatness (Rflat(on) | $\begin{aligned} & 2.5 \\ & 5 \end{aligned}$ $0.75$ | $\begin{aligned} & 6 \\ & \\ & 0.1 \\ & 0.8 \\ & \\ & 1.2 \end{aligned}$ | 0 V to $\mathrm{V}_{\mathrm{DD}}$ <br> 7 <br> 0.8 <br> 1.5 | V <br> $\Omega$ typ <br> $\Omega$ max <br> $\Omega$ typ <br> $\Omega$ max <br> $\Omega$ typ <br> $\Omega$ max | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} ; \\ & \text { see Figure } 13 \\ & \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \end{aligned}$ |
| LEAKAGE CURRENTS Source Off Leakage IS (Off) Channel On Leakage $\mathrm{I}_{\mathrm{D}}, \mathrm{Is}_{\mathrm{s}}(\mathrm{On})$ | $\begin{aligned} & \pm 0.01 \\ & \pm 0.25 \\ & \pm 0.01 \\ & \pm 0.25 \end{aligned}$ | $\begin{aligned} & \pm 0.35 \\ & \pm 0.35 \end{aligned}$ | $1$ | nA typ nA max nA typ nA max | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}=4.5 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=1 \mathrm{~V} / 4.5 \mathrm{~V} ; \end{aligned}$ <br> see Figure 14 $\mathrm{V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}=1 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{S}}=\mathrm{V}_{\mathrm{D}}=4.5 \mathrm{~V} \text {; }$ <br> see Figure 15 |
| DIGITAL INPUTS <br> Input High Voltage, $\mathrm{V}_{\mathrm{INH}}$ Input Low Voltage, VINL Input Current linl or $\mathrm{l}_{\mathrm{NH}}$ | 0.005 |  | $\begin{array}{r} 2.4 \\ 0.8 \\ \\ \pm 0.1 \\ \hline \end{array}$ | $\vee$ min $V$ max <br> $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{1}$ <br> ton <br> toff <br> Break-Before-Make Time Delay, to <br> Off Isolation <br> Channel-to-Channel Crosstalk <br> Bandwidth -3 dB <br> $\mathrm{C}_{\mathrm{s}}$ (Off) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{s}}(\mathrm{On})$ | 7 <br> 3 <br> 8 $\begin{aligned} & -67 \\ & -87 \\ & -62 \\ & -82 \\ & 200 \\ & 7 \\ & 27 \end{aligned}$ |  | 12 | ns typ ns max ns typ ns max ns typ ns min dB typ dB typ dB typ dB typ MHz typ pF typ pF typ | $\begin{aligned} & R_{L}=300 \Omega, C_{L}=35 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{S}}=3 \mathrm{~V} ; \text { see Figure } 16 \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF} \\ & \mathrm{~V}_{\mathrm{S}}=3 \mathrm{~V} ; \text { see Figure } 16 \\ & \mathrm{R}_{\mathrm{L}}=300 \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & \mathrm{~V}_{\mathrm{S} 1}=\mathrm{V}_{\mathrm{S} 2}=3 \mathrm{~V} \text {; see Figure } 17 \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=10 \mathrm{MHz} \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz} \text {; see Figure } 18 \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=10 \mathrm{MHz} \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{f}=1 \mathrm{MHz} \text {; see Figure } 19 \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF} ; \text { see Figure } 20 \end{aligned}$ |
| POWER REQUIREMENTS IDD | 0.001 |  | 1.0 | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V} \mathrm{VD}=5.5 \mathrm{~V} \\ & \text { Digital inputs }=0 \mathrm{~V} \text { or } 5.5 \mathrm{~V} \end{aligned}$ |

[^1]$\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V} \pm 10 \%$ and $\mathrm{GND}=0 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ unless otherwise stated
Table 2.

| Parameter | $25^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Unit | Test Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ANALOG SWITCH <br> Analog Signal Range <br> On Resistance (Ron) <br> On Resistance Match Between Channels ( $\Delta$ Ron) <br> On Resistance Flatness (Rflat(on) | 6 | $\begin{aligned} & 7 \\ & 10 \\ & \\ & 0.1 \\ & 0.8 \\ & 2.5 \\ & \hline \end{aligned}$ | 0 V to $\mathrm{V}_{\mathrm{DD}}$ <br> 12 <br> 0.8 | V <br> $\Omega$ typ <br> $\Omega$ max <br> $\Omega$ typ <br> $\Omega$ max <br> $\Omega$ typ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}} \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} ; \\ & \text { see Figure } 13 \\ & \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{S}}=0 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{S}}=-10 \mathrm{~mA} \end{aligned}$ |
| LEAKAGE CURRENTS <br> Source Off Leakage IS (Off) <br> Channel On Leakage Id, Is (On) | $\begin{aligned} & \pm 0.01 \\ & \pm 0.25 \\ & \pm 0.01 \\ & \pm 0.25 \end{aligned}$ | $\begin{aligned} & \pm 0.35 \\ & \pm 0.35 \end{aligned}$ | 1 <br> 5 | nA typ <br> nA max <br> nA typ <br> nA max | $\begin{aligned} & \mathrm{V} \mathrm{VD}=3.3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{S}}=3 \mathrm{~V} / 1 \mathrm{~V}, \mathrm{~V}_{\mathrm{D}}=1 \mathrm{~V} / 3 \mathrm{~V} ; \end{aligned}$ <br> see Figure 14 $V_{S}=V_{D}=1 \mathrm{~V} \text { or } V_{S}=V_{D}=3 \mathrm{~V} \text {; }$ <br> see Figure 15 |
| DIGITAL INPUTS Input High Voltage, $\mathrm{V}_{\mathrm{INH}}$ Input Low Voltage, VINL Input Current linl or $l_{\text {Inh }}$ | 0.005 | $\begin{aligned} & 2.0 \\ & 0.8 \end{aligned}$ | $\pm 0.1$ | $V$ min <br> V max <br> $\mu \mathrm{A}$ typ <br> $\mu \mathrm{A}$ max | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}$ |
| DYNAMIC CHARACTERISTICS ${ }^{1}$ <br> ton <br> toff <br> Break-Before-Make Time Delay, $t_{D}$ <br> Off Isolation <br> Channel-to-Channel Crosstalk <br> Bandwidth -3 dB <br> $\mathrm{C}_{\mathrm{s}}$ (Off) <br> $\mathrm{C}_{\mathrm{D}}, \mathrm{C}_{\mathrm{s}}(\mathrm{On})$ |  |  | 15 <br> 8 <br> 1 | ns typ ns max ns typ ns max ns typ ns min dB typ dB typ <br> dB typ dB typ MHz typ pF typ pF typ |  |
| POWER REQUIREMENTS IDD | 0.001 |  | 1.0 | $\mu \mathrm{A}$ typ $\mu \mathrm{A}$ max | $\begin{aligned} & \mathrm{V} \mathrm{VD}=3.3 \mathrm{~V} \\ & \text { Digital inputs }=0 \mathrm{~V} \text { or } 3.3 \mathrm{~V} \end{aligned}$ |

[^2]
## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted.

Table 3.

| Parameter | Ratings |
| :---: | :---: |
| $V_{\text {DD }}$ to GND | -0.3 V to +7 V |
| Analog, Digital Input ${ }^{1}$ | $-0.3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V} \text { or } 30 \mathrm{~mA},$ whichever occurs first |
| Peak Current, S or D | 100 mA (pulsed at $1 \mathrm{~ms}, 10 \%$ duty cycle max) |
| Continuous Current, S or D | 30 mA |
| Operating Temperature Range Industrial (B Version) | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $150^{\circ} \mathrm{C}$ |
| SC70 Package, Power Dissipation | 315 mW |
| $\theta_{\text {JA }}$ Thermal Impedance | $332^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {Jc }}$ Thermal Impedance | $120^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead Temperature, Soldering |  |
| Vapor Phase ( 60 sec ) | $215^{\circ} \mathrm{C}$ |
| Infrared (15 sec) | $220^{\circ} \mathrm{C}$ |
| Pb-free Reflow Soldering |  |
| Peak Temperature | $260(+0 /-5)^{\circ} \mathrm{C}$ |
| Time at Peak Temperature | 10 sec to 40 sec |

[^3]Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating can be applied at any one time.

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 2. Pin Configuration

Table 4. Pin Function Descriptions

| Pin Number | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 | IN | Digital control input pin. |
| 2 | V $_{\text {DD }}$ | Most positive power supply pin. |
| 3 | GND | Ground (0V) reference pin. |
| 4 | S1 | Source terminal of the multiplexer. Can be used as input or output. |
| 5 | D | Drain terminal of the multiplexer. Can be used as input or output. |
| 6 | S2 | Source terminal of the multiplexer. Can be used as input or output. |

Table 5. Truth Table

| ADG749 IN | Switch S1 | Switch S2 |
| :--- | :--- | :--- |
| 0 | ON | OFF |
| 1 | OFF | ON |

## TERMINOLOGY

Ron
Ohmic resistance between D and $S$.

## $\Delta$ Ron

On resistance match between any two channels, such as: Ron max - Ron min.
$\mathbf{R}_{\text {flat(ON) }}$
Flatness is defined as the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.
$I_{s}$ (Off)
Source leakage current with the switch off.

## $\mathrm{I}_{\mathrm{D}}, \mathrm{I}_{\mathrm{S}}(\mathbf{O n})$

Channel leakage current with the switch on.
$V_{\mathrm{D}}\left(\mathrm{V}_{\mathrm{s}}\right)$
Analog voltage on Terminals D and S.
Cs (Off)
Off switch source capacitance.
$\mathrm{C}_{\mathrm{D}}, \mathrm{Cs}$ (On)
On switch capacitance.

## Insertion Loss

Loss due to on resistance of the switch.

## ton

Delay between applying the digital control input and the output switching on.
$t_{\text {off }}$
Delay between applying the digital control input and the output switching off.
$t_{\text {D }}$
Off time or on time measured between the $90 \%$ points of both switches, when switching from one address state to another.

## Crosstalk

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

## Off Isolation

A measure of unwanted signal coupling through an off switch.

## Bandwidth

The frequency at which the output is attenuated by -3 dBs .
On Response
The frequency response of the on switch.

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 3. On Resistance vs. $V_{D}\left(V_{S}\right)$ Single Supplies


Figure 4. On Resistance vs. $V_{D}\left(V_{S}\right)$ for Different Temperature, $V_{D D}=3 \mathrm{~V}$


Figure 5. On Resistance vs. $V_{D}\left(V_{S}\right)$ for Different Temperatures, $V_{D D}=5 \mathrm{~V}$


Figure 6. Leakage Currents vs. Temperature


Figure 7. Leakage Currents vs. Temperature


Figure 8. Supply Current vs. Input Switching Frequency


Figure 9. Off Isolation vs. Frequency


Figure 10. Crosstalk vs. Frequency


Figure 11. On Response vs. Frequency


Figure 12. Charge Injection vs. Source Voltage

## ADG749

## TEST CIRCUITS



Figure 13．On Resistance


Figure 14．Off Leakage

Figure 15．On Leakage


Figure 16．Switching Times


Figure 17．Break－Before－Make Time Delay，$t_{D}$


OFF ISOLATION $=20 \log \frac{V_{O U T}}{V_{S}}$


CHANNEL－TO－CHANNEL


INSERTION LOSS $=20 \log \frac{V_{\text {OUT }} \text { WITH SWITCH }}{V_{\text {OUT }} \text { WITHOUT SWITCH }}$ 高

## APPLICATIONS INFORMATION

The ADG749 belongs to Analog Devices' new family of CMOS switches. This series of general-purpose switches has improved switching times, offering lower on resistance, higher bandwidths, low power consumption, and low leakage currents.

## ADG749 SUPPLY VOLTAGES

Functionality of the ADG749 extends from 1.8 V to 5.5 V single supply, which makes it ideal for battery-powered instruments, where power efficiency and performance are important design parameters.
It is important to note that the supply voltage affects the input signal range, the on resistance, and the switching times of the part. By taking a look at the typical performance characteristics and the specifications, the effects of the power supplies can be clearly seen.

For $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}$ operation, RoN is typically $40 \Omega$ over the temperature range.

## ON RESPONSE VS. FREQUENCY

Figure 21 illustrates the parasitic components that affect the ac performance of CMOS switches (the switch is shown surrounded by a box). Additional external capacitances will further degrade some performance. These capacitances affect feedthrough, crosstalk, and system bandwidth.


Figure 21. Switch Represented by Equivalent Parasitic Components
The transfer function that describes the equivalent diagram of the switch (Figure 21) is of the form $A(s)$ shown below.

$$
A(s)=R_{T}\left[\frac{s\left(R_{O N} C_{D S}\right)+1}{s\left(R_{T} R_{O N} C_{D S}\right)+1}\right]
$$

where:

$$
\begin{aligned}
& R_{T}=R_{L O A D} /\left(R_{L O A D}+R_{O N}\right) \\
& C_{T}=C_{L O A D}+C_{D}+C_{D S}
\end{aligned}
$$

The signal transfer characteristic is dependent on the switch channel capacitance, $C_{D S}$. This capacitance creates a frequency
zero in the numerator of the transfer function $A(s)$. Because the switch on resistance is small, this zero usually occurs at high frequencies. The bandwidth is a function of the switch output capacitance combined with $C_{D S}$ and the load capacitance. The frequency pole corresponding to these capacitances appears in the denominator of $A(s)$.
The dominant effect of the output capacitance, $C_{D}$, causes the pole breakpoint frequency to occur first. Therefore, in order to maximize bandwidth, a switch must have a low input and output capacitance and low on resistance. The on response vs. frequency plot for the ADG749 is shown in Figure 11.

## OFF ISOLATION

Off isolation is a measure of the input signal coupled through an off switch to the switch output. The capacitance, $C_{D S}$, couples the input signal to the output load when the switch is off, as shown in Figure 22.


Figure 22. Off Isolation is Affected by External Load Resistance and Capacitance

The larger the value of CDS, the larger the values of feedthrough that will be produced. The typical performance characteristic graph of Figure 9 illustrates the drop in off isolation as a function of frequency. From dc to roughly 200 kHz , the switch shows better than -95 dB isolation. Up to frequencies of 10 MHz , the off isolation remains better than -67 dB . As the frequency increases, more and more of the input signal is coupled through to the output. Off isolation can be maximized by choosing a switch with the smallest $C_{D S}$ possible. The values of load resistance and capacitance also affect off isolation, since they contribute to the coefficients of the poles and zeros in the transfer function of the switch when open.

$$
A(s)=\left[\frac{s\left(R_{L O A D} C_{D S}\right)}{s\left(R_{L O A D}\right)\left(C_{L O A D}+C_{D}+C_{D S}\right)+1}\right]
$$

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-203-AB

Figure 23. 6-Lead Thin Shrink Small Outline Transistor Package [SC70] (KS-6)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model $^{1}$ | Temperature range | Package Description | Package Option | Branding $^{2}$ |
| :--- | :--- | :--- | :--- | :--- |
| ADG749BKSZ-R2 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-Lead Thin Shrink Small Outline Transistor Package $[\mathrm{SC} 70]$ | $\mathrm{KS}-6$ | S1M |
| ADG749BKSZ-REEL | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-Lead Thin Shrink Small Outline Transistor Package $[\mathrm{SC} 70]$ | $\mathrm{KS}-6$ | S1M |
| ADG749BKSZ-REEL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 6-Lead Thin Shrink Small Outline Transistor Package $[\mathrm{SC} 70]$ | KS-6 | S1M |

${ }^{1} Z=$ RoHS Compliant Part.
${ }^{2}$ Branding on this package is limited to three characters due to space constraints.

# Mouser Electronics 

Authorized Distributor

Click to View Pricing, Inventory, Delivery \& Lifecycle Information:

Analog Devices Inc.:
ADG749BKSZ-REEL ADG749BKSZ-REEL7


[^0]:    Rev. C
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[^1]:    ${ }^{1}$ Guaranteed by design, not subject to production test.

[^2]:    ${ }^{1}$ Guaranteed by design, not subject to production test.

[^3]:    ${ }^{1}$ Overvoltage at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

